IRF830

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC) Configuration

Q_a max. (nC)

Power MOSFET

S

N-Channel MOSFET

1.5

500

38

5.0

22

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF830PbF
Lead (Pb)-free and halogen-free	IRF830PbF-BE3

ABSOLUTE MAXIMUM RATINGS (To	; = 25 °C, ur	less otherwi	ise noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	v	
Gate-source voltage			V _{GS}	± 20		
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	4.5		
		T _C = 100 °C		2.9	А	
Pulsed drain current ^a			I _{DM}	18	1	
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy ^b			E _{AS}	280	mJ	
Repetitive avalanche current ^a			I _{AR}	4.5	А	
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ	
Maximum power dissipation	T _C =	25 °C	PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	3.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 24 mH, R_g = 25 Ω , I_{AS} = 4.5 A (see fig. 12)

c.
$$I_{SD} \le 4.5$$
 A, dI/dt ≤ 75 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.	TYP. MAX.				UNIT	
Maximum junction-to-ambient	R _{thJA}	-	- 62					
Case-to-sink, flat, greased surface	R _{thCS}	0.50 - 1.7		°C/W		°C/W		
Maximum junction-to-case (drain)	R _{thJC}							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	vise noted)						
PARAMETER	SYMBOL	-	CONDITIONS	3	MIN.	TYP.	MAX.	UNIT
Static					L	I.	1	<u> </u>
Drain-source breakdown voltage	V _{DS}	V _{GS} =	0 V, I _D = 250 μ	A	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D =	1 mA	-	0.61	-	V/°C
Gate-source threshold voltage	V _{GS(th)}		V _{GS} , I _D = 250 µ		2.0	-	4.0	V
Gate-source leakage	I _{GSS}	-	$_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
			500 V, V _{GS} = 0	V	-	-	25	
Zero gate voltage drain current	ent I_{DSS} $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			-	-	250	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.		-	-	1.5	Ω
Forward transconductance	9 _{fs}		50 V, I _D = 2.7 A	b	2.5	-	-	S
Dynamic	+		_		<u>.</u>	Į	<u>I</u>	
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	610	-	
Output capacitance	C _{oss}		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	160	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	68	-		
Total gate charge	Qg			-	-	38		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V} \qquad \begin{array}{c} I_{D} = 3.1 \text{ A}, V_{DS} = 400 \text{ V}, \\ \text{see fig. 6 and } 13^{\text{ b}} \end{array}$		-	-	5.0	nC
Gate-drain charge	Q _{gd}				-	-	22	
Turn-on delay Time	t _{d(on)}				-	8.2	-	
Rise time	tr	- V _{DD} =	V_{DD} = 250 V, I _D = 3.1 A R _g = 12 Ω , R _D = 79 Ω , see fig. 10 ^b			16	-	ns
Turn-off delay time	t _{d(off)}					42	-	
Fall time	t _f				-	16	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH
Internal source inductance	Ls				-	7.5	-	
Gate input resistance	Rg	f = 1 MHz, open drain		0.5	-	2.7	Ω	
Drain-Source Body Diode Characterist	÷							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.5	A	
Pulsed diode forward current ^a	I _{SM}			-	-	18		
Body diode voltage	V _{SD}	T _J = 25 °C,	$I_{\rm S}$ = 4.5 A, $V_{\rm GS}$	= 0 V ^b	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	- T _J = 25 °C, I _F = 3.1 A, dl/dt = 100 A/μs ^b			-	320	640	ns
Body diode reverse recovery charge	Q _{rr}				-	1.0	2.0	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and					L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

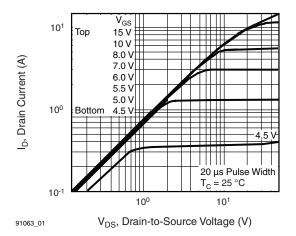


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

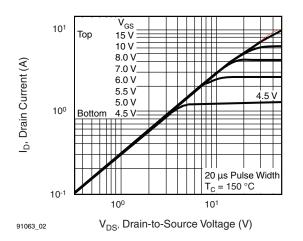


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

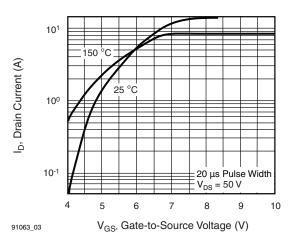


Fig. 3 - Typical Transfer Characteristics

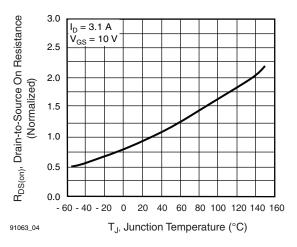


Fig. 4 - Normalized On-Resistance vs. Temperature

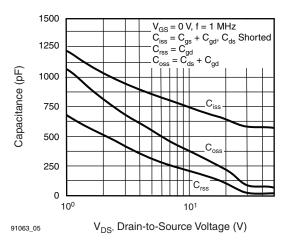


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

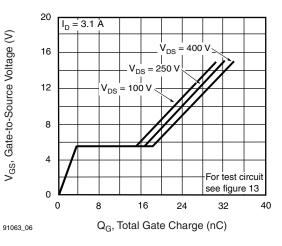


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

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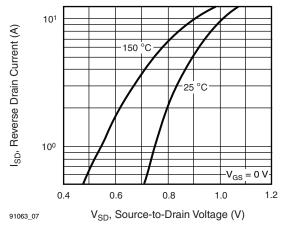


Fig. 7 - Typical Source-Drain Diode Forward Voltage

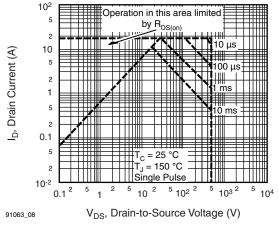


Fig. 8 - Maximum Safe Operating Area

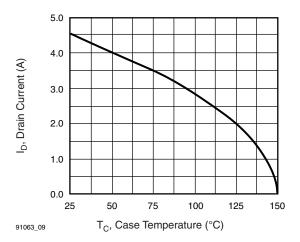


Fig. 9 - Maximum Drain Current vs. Case Temperature

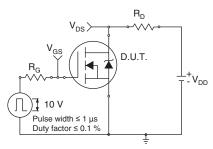


Fig. 10a - Switching Time Test Circuit

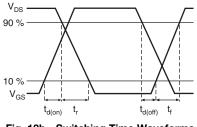
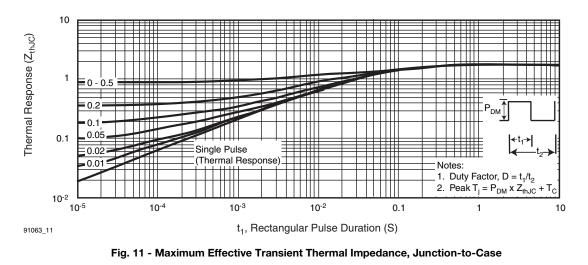


Fig. 10b - Switching Time Waveforms



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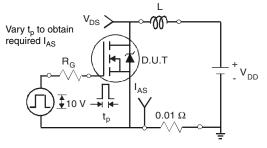


Fig. 12a - Unclamped Inductive Test Circuit

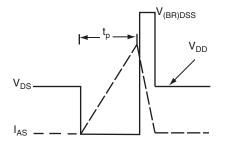


Fig. 12b - Unclamped Inductive Waveforms

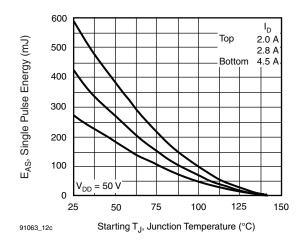


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

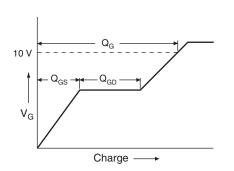


Fig. 13a - Basic Gate Charge Waveform

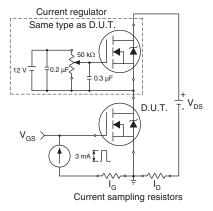
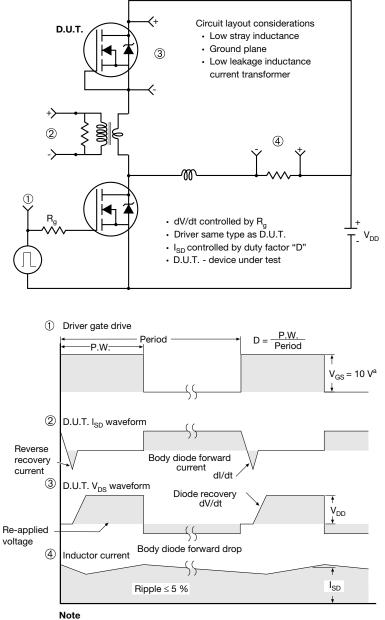


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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